

# **MMSZ4684**

## **General Description**

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

#### **Features**

- · Compact surface mount with same footprint as mini-melf
- 500mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16kV) per Human Body Model

# **Ordering**

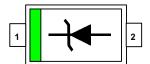
• 7 inch reel (178mm); 8mm Tape; 3,000 units per reel.

## Absolute Maximum Ratings (note 1) T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C
TJ	Maximum Junction Temperature	-55 ~ 150	°C
$P_D$	Total Power Dissipation at 25°C Derate above 25°C	500 6.7	mW mW/°C
$R_{QJA}$	Thermal Resistance Junction to Ambient	340	°C/W
R <sub>QJA</sub> R <sub>QJL</sub>	Thermal Resistance Junction to Lead	150	°C/W
$\Delta V_Z$	Maximum Voltage Change (note 2)	950	mV
Lead Solder Temperature (Max 10 second duration)		260	°C
Nominal Zener	Voltage (V <sub>Z</sub> ) at 50μA	3.3	V

Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. Note 2: Voltage change is equal to the difference between  $V_Z$  at  $100\mu A$  and  $V_Z$  at  $10\mu A$ .

Top Mark: CK 1: Cathode 2: Anode

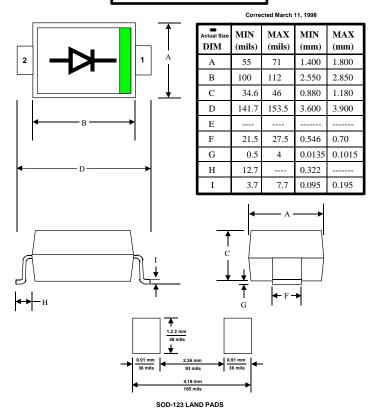


# Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Characteristics	Test Conditions	Min.	Max.	Units
$V_Z$	Zener Voltage	$I_{ZT} = 50\mu A_{D.C}$	3.14	3.47	V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = 1.5V		7.5	μΑ
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 10mA		900	mV
$\Delta V_Z$	Delta Zener Voltage (Note 2)	I <sub>ZT</sub> = 100μA to 10μA		950	mV

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# SOD-123 PACKAGE PACKAGE CODE = (D6) Fairchild Semiconductor's Criteria



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